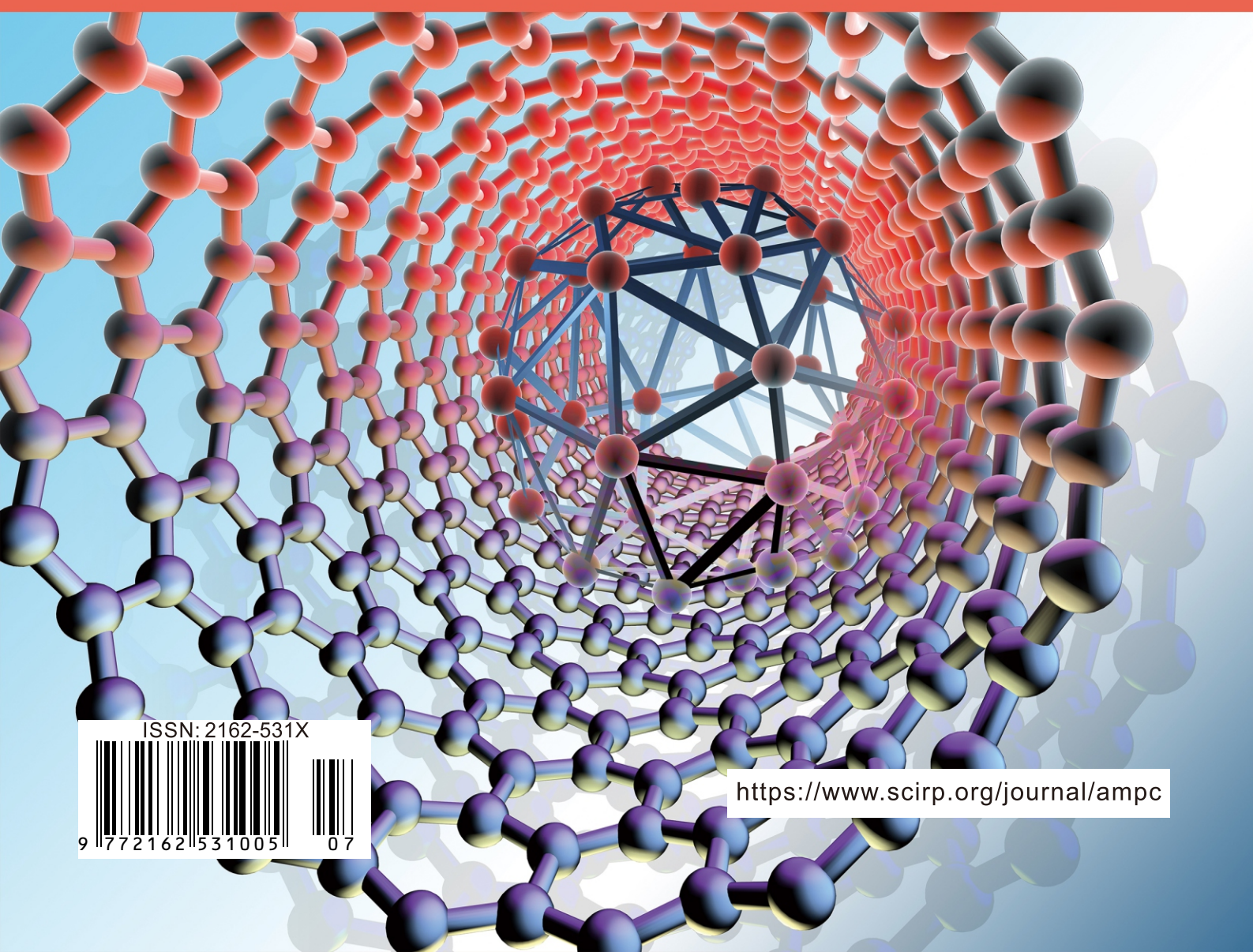


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Table of Contents

Volume 10 Number 7

July 2020

Required CIGS and CIGS/Mo Interface Properties for High-Efficiency Cu(In, Ga)Se₂ Based Solar Cells

S. Ouédraogo, M. B. Kébré, A. T. Ngoupo, D. Oubda, F. Zougmore, J.-M. Ndjaka.....151

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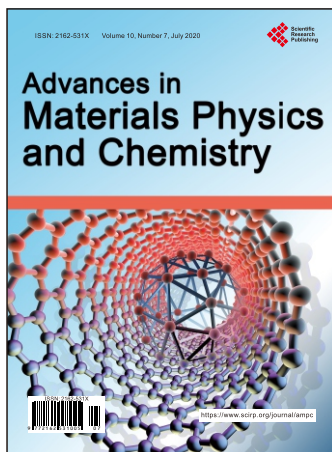
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